

Cu-PHC

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Comparable standards: UNS C10300 • EN CW020A • JIS C103
 Aurubis designations: C103 • SM 0011 • XLP • PNA 209

Description Cu-PHC is a deoxidized, oxygen-free copper with a very low residual phosphorus content. It has very good formability, weldability and brazability with very high electrical conductivity (min. 100% IACS).
 Fields of application are components of electrical engineering, base plates for power modules, process equipment manufacture and in the cable industry.

Composition

Cu	P
[%]	[%]
min 99.95	0.001-0.005

Composition of this alloy is in accordance with RoHS for electric & electronic components and ELV for the automotive industry.

Physical properties

Melting point	Density	c _p @ 20°C	Young's modulus	Thermal cond.	Electrical cond.		α @20-300°C
					[°C]	[g/cm ³]	
1083	8.94	0.377	127	390	≥ 58	≥ 100	17.7

Note: The specified conductivity applies to the soft condition only.

c_p specific heat capacity
 α coefficient of thermal expansion

Mechanical properties

	Tensile Strength	Yield Strength	Elongation A ₅₀	Hardness HV	Bend ratio 90° [r]	
					[MPa]	[MPa]
R220	220-260	≤ 140	≥ 33	40-65	0	0
R240	240-300	≥ 180	≥ 8	65-95	0	0
R290	290-360	≥ 250	≥ 4	90-110	0	0
R360	≥ 360	≥ 320	≥ 2	≥ 110	0	0.5

r = x * t (thickness t ≤ 0.5mm)

GW bend axis transverse to rolling direction. BW bend axis parallel to rolling direction.

Fabrication properties

Cold formability	excellent
Hot formability	excellent
Soldering	excellent
Brazing	excellent
Oxyacetylene welding	fair
Gas shielded arc welding	excellent
Resistance welding	not recommended
Machinability	not recommended

Electrical conductivity

The electrical conductivity depends on chemical composition, the level of cold deformation and the grain size. A high level of deformation as well as a small grain size decrease the conductivity.

**Corrosion
Resistance**

Copper is resistant to: Natural and industrial atmospheres as well as maritime air, drinking and service water, non oxidizing acids, alkaline solutions and neutral saline solutions.
Copper is not resistant to: Ammonia, halogenide, cyanide and hydrogen sulfide solutions and atmospheres, oxidizing acids and sea water (especially at high flow rates).

Typical uses

Telecommunication cables, terminals, clad products, busbars, base plates for power modules, electrical conductors

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